

## Product / Process Change Notification JLIO-7KMTQW

The information below reflects a change that is being implemented.

Notice Date: 10/21/2008

Product Category: Battery Management; Infrared Devices; Linear Devices; Mixed Signal Devices; Power Management; Thermal Management; dsPIC; CAN Communication; Ethernet Communication; Infrared Communication; 11xxx; 24xxx; 25xxx; 34xxx; 93xxx; PIC10xxx; PIC12xxx; PIC16xxx; PIC17xxx; PIC18xxx; PIC24xxx; PIC32xxx ; rPIC; RFID; SDP

Notification Subject: CCB#855: CHANGE FORMAT AND ADD QUANTITY BARCODE FOR BOTH THE STANDARD DIE/WAFER AND BUY/RESELL INNER BOX LABELS AT MTAI ASSEMBLY.

Notification Body:  
PCN Status: Final Notification

Microchip Part#s Affected:  
All die/wafer sales and all buy/resell products.

Description of Change:  
Change Format and add quantity barcode to the standard die/wafer inner box label and Buy/ Resell inner box label at MTAI. Please reference the attachment for samples of die/wafer inner box label and buy/resell inner box label.

Impacts to Data Sheet:  
NONE

Reason for Change:  
OPERATIONAL EFFICIENCY AND SHIPPING QUALITY IMPROVEMENT

Change Implementation Status:  
In Progress

Estimated Change Implementation Date(s):  
Nov 17th, 2008 (Date Code: 0847)

Note: Please be advised that only new assembly lots will receive the updated labels. Existing inventory will not be re-labeled. During a transitional period, you may receive die/wafer and buy/resell products packaged in inner boxes with either label.

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking)  
NEW INNER BOX LABEL FORMAT